

1752-2 1.1

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

ICP Web Site for information on IPC-1752 Standard http://www.ipc.org/IPC-175x

Declaration Class* Form Type* Distribute Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Infomation

	Infoliation							
Supplier Information								
Company Name *	Company Unique ID	ompany Unique ID Unique ID Authority Response Date*						
Fairchild Semiconductor	00-489-5751	Dun & Bradstreet	Sat, Aug 09, 2014 03:45 AM					
Contact Name *	Title - Contact	Phone - Contact *	Email - Contact *					
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Authorized Representative *	Title - Representative	Phone - Representative *	Email - Representative *					
David Lancaster	Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com					

Requester Item Number	Mfr I	tem Number	Mfr Item Name		Effective Date	Version		Manufacturing Site	Weight*	UOM	Unit Type	
MM74HCT573WM	MM74HCT573WMX MM74H		SOIC-20W				INTERNAL PENANG		0.532373	g	Each	
Manufacturing Process Information												
Terminal Finish	Base Alloy	J-STD-02	D-020 MSL Rating		Peak Process Body Temperature		Max Time at Peak Temperature		No Reflow cycles			
Matte Tin (Sn)	CU Alloy		1			260 C		30 seconds			3	

* Required Field

 RoHS Material Composition Declaration
 Declaration Type * Custom

 RoHS Directive 2011/65/EU
 RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE)

This document is Fairchild Semiconductor's statement regarding the directive 2011/65/EU of the European Parliament and of the council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS Recast). The content of this document is based upon information collected from Fairchild Semiconductor supply chain, manufacturing facilities and affiliates worldwide.

The FSC part number listed above and the homogenous materials in the product are compliant with the Directive 2011/65/EU. Fairchild has implemented systems to ensure our products are compliant to environmental regulations and laws worldwide. However, not all materials in Fairchild's products may have been independently verified regarding substance content. In the event of any issues arising from information in this document, the warranty section of Fairchild's standard terms and conditions of sale shall apply, unless alternate contracts have been agreed upon in writing by both parties.

Note: The substance content disclosed herewith is approximate and is based on various methods including, engineering calculations, supplier surveys, Material Safety Data Sheets, analytical measurements. Fairchild may update this document without notification. This statement may not include information regarding the miniscule quantities of dopant and metal materials in the electrical devices contained within the finished product. CAS numbers listed for Resin substances are generic and may contain alternate substances of similar composition.

RoHS Declaration * 1 - Item

1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance * Accepted

Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. Exemption List Version EL-2011/534/EU

Declaration Signature

and Loncosto

Supplier Signature

DAVID LANCASTER - PRODUCT ECOLOGY MANAGER

Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name SOIC-20W

Component	Material	Weight (mg)	Jig Level	Substance Category	Substance	Weight (mg)	CAS	PPM
Chip	Other inorganic materials	6.990	Supplier		Silicon	6.990	7440-21-3	13130
Die Attach	Other Organic Materials	0.707	Supplier		Phenolic resin	0.152	54208-63-8	286
			Supplier		Silver	0.555	7440-22-4	1043
Encapsulation	Thermoplastics	414.560	В	Antimony/Antimony Compounds	Antimony Trioxide	8.300	1309-64-4	15591
			В	Brominated Flame Retardants (other than PBCs or PBDEs)	Bromine Resin	4.150	6386-73-8	7795
			Supplier		Carbon Black	3.110	1333-86-4	5842
			Supplier		Epoxy Resin	120.000	29690-82-2	225406
			Supplier		Silica, vitreous	279.000	60676-86-0	524068
Lead Frame	Copper & its alloys	105.720	Supplier		Copper	103.000	7440-50-8	193473
			Supplier		Iron	2.540	7439-89-6	4771
			Supplier		Phosphorus	0.042	7723-14-0	80
			Supplier		Zinc	0.138	7440-66-6	259
Plating	Other Nonferrous metals & alloys	3.900	Supplier		Tin	3.900	7440-31-5	7326
Wire Bond	Precious metals	0.496	Supplier		Gold	0.496	7440-57-5	932